

CD4040A Types

CMOS 12-Stage Ripple-Carry Binary Counter/Divider

Features:

- Medium-speed operation . . . 5 MHz (typ.) input pulse rate at  $V_{DD} - V_{SS} = 10\text{ V}$
- Low output impedance . . . 750  $\Omega$  (typ.) at  $V_{DD} - V_{SS} = 10\text{ V}$  and  $V_{DS} = 0.5\text{ V}$
- Common reset ■ Fully static operation
- All 12 buffered outputs available
- Low-power TTL compatible
- Quiescent current specified to 15 V
- Maximum input leakage current of 1  $\mu\text{A}$  at 15 V (full package-temperature range)
- 1-V noise margin (full package-temperature range)

Applications:

- Frequency-dividing circuits
- Time-delay circuits ■ Control counters

The RCA-CD4040A consists of an input-pulse-shaping circuit and 12 ripple-carry binary counter stages. Resetting the counter to the all-0's state is accomplished by a high-level on the reset line. A master-slave flip-flop configuration is utilized for each counter stage. The state of the counter is advanced one step in binary order on the negative-going transition of the input pulse. All inputs and outputs are fully buffered.

These types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic package (E suffix), 16-lead ceramic flat package (K suffix), and in chip form (H suffix).

RECOMMENDED OPERATING CONDITIONS at  $T_A = 25^\circ\text{C}$ , Except as Noted:

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges :

CHARACTERISTIC	V <sub>DD</sub> (V)	LIMITS				UNITS
		D, F, K, H Packages		E Package		
		Min.	Max.	Min.	Max.	
Supply Voltage Range (For $T_A = \text{Full Package-Temperature Range}$ )		3	12	3	12	V
Input Pulse Width, $t_W$	5 10	400 110	— —	500 125	— —	ns
Input-Pulse Frequency, $f_\phi$	5 10	dc dc	1.5 4	dc dc	1.5 4	MHz
Input-Pulse Rise or Fall Time, $t_{r\phi}, t_{f\phi}$	5 10	15 15	— —	15 15	— —	$\mu\text{s}$
Reset Pulse Width, $t_W$	5 10	1000 500	— —	1250 600	— —	ns

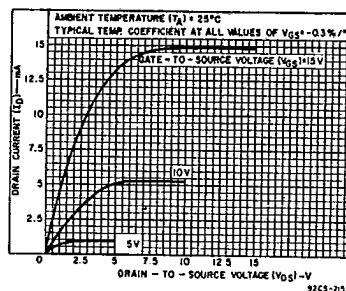
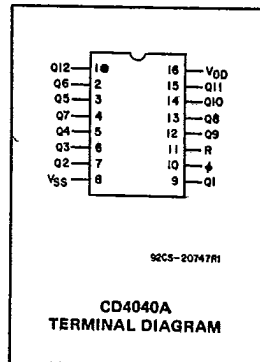


Fig. 2 - Typical output n-channel drain characteristics.

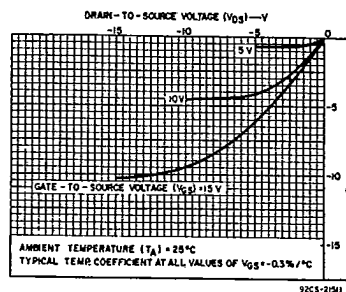


Fig. 3 - Typical output p-channel drain characteristics.

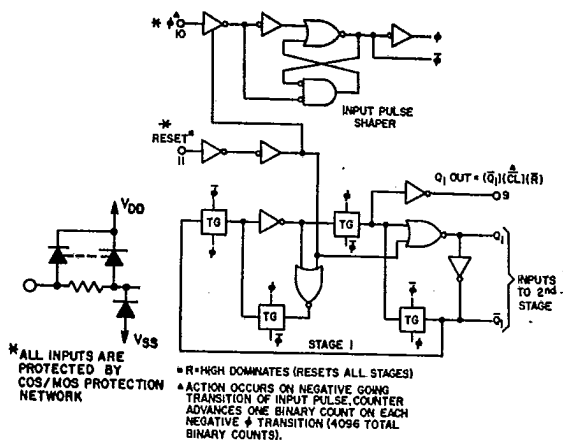


Fig. 1 - Logic diagram of CD4040A input pulse shaper and 1 of 12 stages.

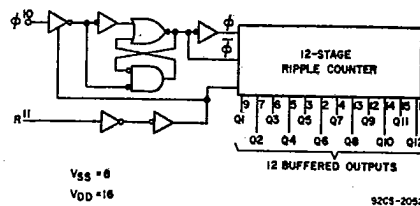


Fig. 4 - Functional diagram.

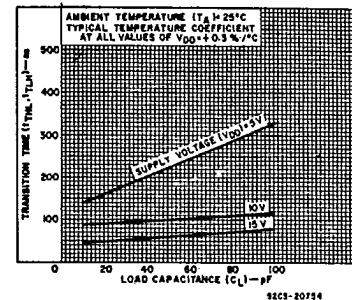
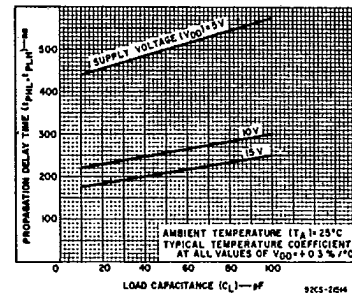
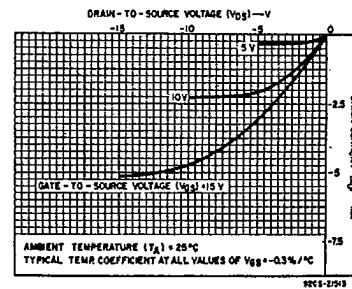
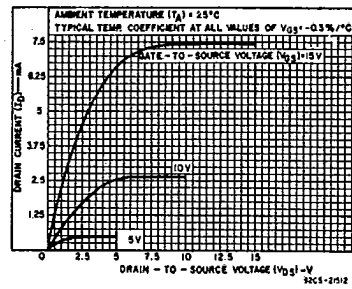
CD4040A Types

MAXIMUM RATINGS, Absolute-Maximum Values:

STORAGE-TEMPERATURE RANGE ( $T_{stg}$ )	-66 to +150°C
OPERATING-TEMPERATURE RANGE ( $T_A$ ):	
PACKAGE TYPES D, F, K, H	-55 to +125°C
PACKAGE TYPE E	-40 to +85°C
DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ )	
(Voltages referenced to $V_{SS}$ Terminal)	-0.5 to +15 V
POWER DISSIPATION PER PACKAGE ( $P_D$ ):	
FOR $T_A = -40$ to +60°C (PACKAGE TYPE E)	500 mW
FOR $T_A = +60$ to +85°C (PACKAGE TYPE E)	Derate Linearly at 12 mW/°C to 200 mW
FOR $T_A = -55$ to +100°C (PACKAGE TYPES D, F, K)	500 mW
FOR $T_A = +100$ to +125°C (PACKAGE TYPES D, F, K)	Derate Linearly at 12 mW/°C to 200 mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (ALL PACKAGE TYPES)	100 mW
INPUT VOLTAGE RANGE, ALL INPUTS	-0.5 to $V_{DD} + 0.5$ V
LEAD TEMPERATURE (DURING SOLDERING):	
At distance 1/16 ± 1/32 inch (1.59 ± 0.79 mm) from case for 10 s max.	+265°C

STATIC ELECTRICAL CHARACTERISTICS

Characteristic	Conditions			Limits at Indicated Temperatures (°C)								Units
				D, F, K, H Packages				E Package				
	$V_O$ (V)	$V_{IN}$ (V)	$V_{DD}$ (V)	-55	+25 Typ. Limit	+125	-40	+25 Typ. Limit	+85			
Quiescent Device Current, $I_L$ Max.	-	-	5	15	0.6	15	900	50	1	50	700	$\mu A$
	-	-	10	25	1	25	1500	100	2	100	1400	
	-	-	15	50	2.5	50	2000	500	5	500	5000	
Output Voltage: Low-Level, $V_{OL}$	-	5	5	0 Typ.; 0.05 Max.								V
	-	10	10	0 Typ.; 0.05 Max.								
	High-Level, $V_{OH}$	-	0	5	4.95 Min.; 5 Typ.							
Noise Immunity: Inputs Low, $V_{NL}$	4.2	-	5	1.5 Min.; 2.25 Typ.								V
	9	-	10	3 Min.; 4.5 Typ.								
	Inputs High, $V_{NH}$	0.8	-	5	1.5 Min.; 2.25 Typ.							
Noise Margin: Inputs Low, $V_{NML}$	4.5	-	5	1 Min.								V
	9	-	10	1 Min.								
	Inputs High, $V_{NMH}$	0.5	-	5	1 Min.							
Output Drive Current: N-Channel (Sink), $I_{DN}$ Min.	0.5	-	5	0.22	0.36	0.145	0.102	0.21	0.36	0.08	0.056	mA
	0.5	-	10	0.44	0.75	0.4	0.250	0.42	0.75	0.2	0.14	
P-Channel (Source), $I_{DP}$ Min.	4.5	-	5	-0.15	-0.25	-0.1	-0.07	-0.15	-0.25	-0.06	-0.04	
	9.5	-	10	-0.03	-0.5	-0.25	-0.175	-0.29	-0.5	-0.15	-0.1	
Input Leakage Current, $I_{IL}, I_{IH}$	Any Input			$\pm 10^{-5}$ Typ., $\pm 1$ Max.								$\mu A$
	-	-	15									



# CD4040A Types

DYNAMIC ELECTRICAL CHARACTERISTICS at  $T_A = 25^\circ\text{C}$ , Input  $t_r, t_f = 20 \text{ ns}$ ,  $C_L = 15 \text{ pF}$ ,  $R_L = 200 \text{ k}\Omega$

Characteristic	Test Conditions	LIMITS						Units	
		VDD (V)	D, F, K, H Packages			E Package			
			Min.	Typ.	Max.	Min.	Typ.		Max.
<b>Input-Pulse Operation</b>									
Propagation Delay Time, $t_{PLH}, t_{PHL}$		5	—	450	900	—	450	950	ns
		10	—	225	450	—	225	475	
Transition Time, $t_{THL}, t_{TLH}$		5	—	150	300	—	150	350	ns
		10	—	75	150	—	75	175	
Maximum Input-Pulse Frequency, $f_\phi$		5	1.5	2.5	—	1.5	2.5	—	MHz
		10	4	6	—	4	6	—	
Minimum Input-Pulse Width, $t_W$	$f = 100 \text{ kHz}$	5	—	200	400	—	200	500	ns
		10	—	75	110	—	75	125	
Input-Pulse Rise & Fall Time, $t_{r\phi}, t_{f\phi}$		5	—	—	15	—	—	15	$\mu\text{s}$
		10	—	—	7.5	—	—	7.5	
Average Input Capacitance, $C_i$	Any Input		—	5	—	—	5	—	pF
<b>Reset Operation</b>									
Propagation Delay Time, $t_{PHL}$		5	—	500	1000	—	500	1250	ns
		10	—	250	500	—	250	600	
Minimum Reset Pulse Width, $t_W$		5	—	500	1000	—	500	1250	ns
		10	—	250	500	—	250	600	

- Measured from the 50% level of the negative input pulse edge to the 50% level of either the positive or negative edge of the Q1 output (pin 9); or measured from the negative edge of Q1 through Q11 outputs to the positive or negative edge of the next higher output.
- ▲ Maximum input rise or fall time for functional operation.
- Measured from the positive edge of the reset pulse to the negative edge of any output (Q1 to Q12).

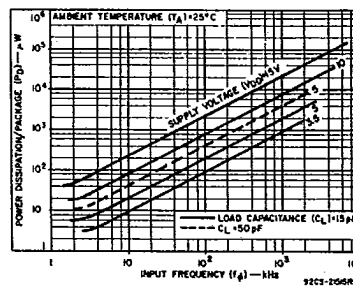


Fig.9 - Typical dissipation characteristics.

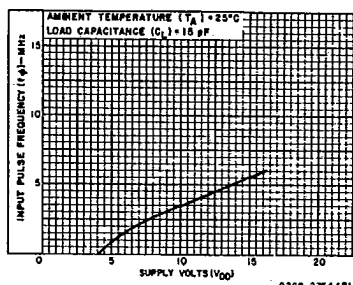


Fig.10 - Typical input-pulse frequency vs. supply voltage.

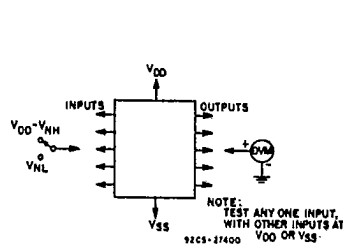


Fig. 11- Noise-immunity test circuit.

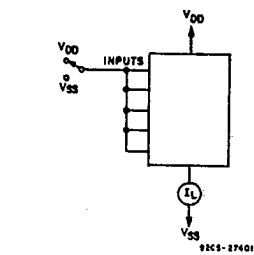


Fig.12 - Quiescent-device-current test circuit.

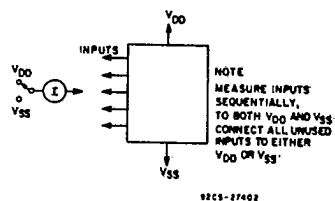
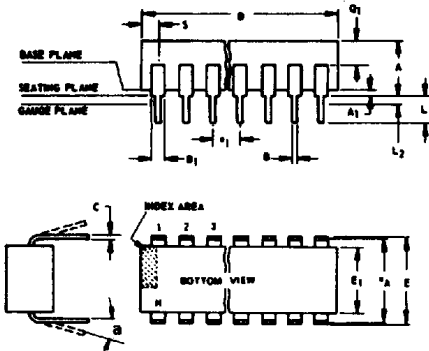


Fig.13 - Input-leakage-current test circuit.

## Dimensional Outlines

### Dual-In-Line Welded-Seal Ceramic Packages



**NOTES:**

Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.

- When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
- Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
- e<sub>A</sub> applies in zone L<sub>2</sub> when unit installed.
- a applies to spread leads prior to installation.
- N is the maximum quantity of lead positions.
- N<sub>1</sub> is the quantity of allowable missing leads.

(D) SUFFIX (JEDEC MO-001-AD)  
14-Lead Dual-In-Line Welded-Seal  
Ceramic Package

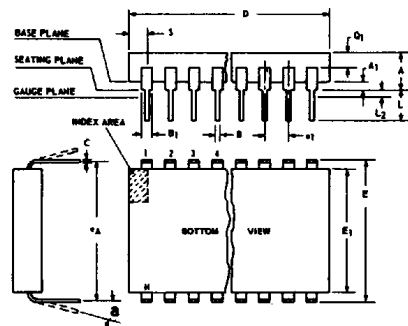
SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.160		3.05	4.06
A <sub>1</sub>	0.020	0.065		0.51	1.65
B	0.014	0.020		0.356	0.508
B <sub>1</sub>	0.050	0.065		1.27	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.770		18.93	19.55
E	0.300	0.325		7.62	8.25
E <sub>1</sub>	0.240	0.260		6.10	6.60
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0.000	0.030		0.000	0.76
a	0°	15°	4	0°	15°
N	14		5	14	
N <sub>1</sub>	0		6	0	
Q <sub>1</sub>	0.050	0.085		1.27	2.15
S	0.065	0.090		1.66	2.28

92SS-4411R2

(D) SUFFIX (JEDEC MO-001-AE)  
16-Lead Dual-In-Line Welded-Seal  
Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.160		3.05	4.06
A <sub>1</sub>	0.020	0.065		0.51	1.65
B	0.014	0.020		0.356	0.508
B <sub>1</sub>	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.785		18.93	19.93
E	0.300	0.325		7.62	8.25
E <sub>1</sub>	0.240	0.260		6.10	6.60
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0.000	0.030		0.000	0.76
a	0°	15°	4	0°	15°
N	16		5	16	
N <sub>1</sub>	0		6	0	
Q <sub>1</sub>	0.050	0.085		1.27	2.15
S	0.015	0.060		0.39	1.52

92SS-4266R5



**NOTES:**

Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.

- When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
- Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
- e<sub>A</sub> applies in zone L<sub>2</sub> when unit installed.
- a applies to spread leads prior to installation.
- N is the maximum quantity of lead positions.
- N<sub>1</sub> is the quantity of allowable missing leads.

(D) SUFFIX (JEDEC MO-015-AG)  
24-Lead Dual-In-Line Welded-Seal  
Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.090	0.200		2.29	5.08
A <sub>1</sub>	0.020	0.070		0.51	1.78
B	0.015	0.020		0.381	0.508
B <sub>1</sub>	0.045	0.055		1.143	1.397
C	0.008	0.012	1	0.204	0.304
D	1.15	1.22		29.21	30.98
E	0.600	0.625		15.24	15.87
E <sub>1</sub>	0.480	0.520		12.20	13.20
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.600 TP		2, 3	15.24 TP	
L	0.100	0.180		2.54	4.57
L <sub>2</sub>	0.000	0.030		0.00	0.76
a	0°	15°	4	0°	15°
N	24		5	24	
N <sub>1</sub>	0		6	0	
Q <sub>1</sub>	0.020	0.080		0.51	2.03
S	0.020	0.060		0.51	1.52

92CS-19948R4

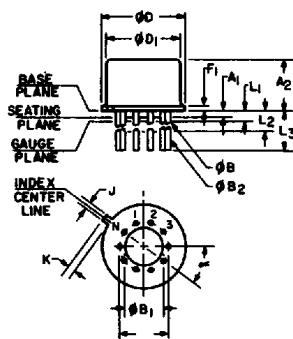
(D) SUFFIX (JEDEC MO-015-AH)  
28-Lead Dual-In-Line Welded-Seal  
Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.090	0.200		2.29	5
A <sub>1</sub>	0	0.070	2	0	1.77
B	0.015	0.020		0.381	0.508
B <sub>1</sub>	0.015	0.065		0.39	1.39
C	0.008	0.012	1	0.204	0.304
D	1.380	1.420		35.06	36.06
E	0.600	0.625		15.24	15.87
E <sub>1</sub>	0.485	0.515		12.32	13.08
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.600 TP		2, 3	15.24 TP	
L	0.100	0.200		2.54	5
L <sub>2</sub>	0	0.030		0	0.76
a	0°	15°	4	0°	15°
N	28		5	28	
N <sub>1</sub>	0		6	0	
Q <sub>1</sub>	0.020	0.070		0.51	1.77
S	0.040	0.070		1.02	1.77

92CM-20250R2

### TO-5 Style Package

(T) SUFFIX (JEDEC MO-006-AG)  
12-Lead Metal Package



92CS-19774

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
a	0.230		2	5.84 TP	
A <sub>1</sub>	0	0		0	0
A <sub>2</sub>	0.165	0.185		4.19	4.70
A	0.016	0.019	3	0.407	0.482
φB <sub>1</sub>	0	0		0	0
φB <sub>2</sub>	0.016	0.021	3	0.407	0.533
φD	0.335	0.370		8.51	9.39
φD <sub>1</sub>	0.305	0.335		7.75	8.50
F <sub>1</sub>	0.020	0.040		0.51	1.01
j	0.028	0.034		0.712	0.863
k	0.029	0.045	4	0.74	1.14
L <sub>1</sub>	0.000	0.050	3	0.00	1.27
L <sub>2</sub>	0.250	0.500	3	6.4	12.7
L <sub>3</sub>	0.500	0.562	3	12.7	14.27
a	30° TP			30° TP	
N	12		6	12	
N <sub>1</sub>	1		5	1	

**NOTES:**

- Refer to Rules for Dimensioning Axial Lead Product Outlines.
- Leads at gauge plane within 0.007" (0.178 mm) radius of True Position (TP) at maximum material condition.
- φB applies between L<sub>1</sub> and L<sub>2</sub>. φB<sub>2</sub> applies between L<sub>2</sub> and 0.500" (12.70 mm) from seating plane. Diameter is uncontrolled in L<sub>1</sub> and beyond 0.500" (12.70 mm).
- Measure from Max. φD.
- N<sub>1</sub> is the quantity of allowable missing leads.
- N is the maximum quantity of lead positions.

Dimensional Outlines (Cont'd)

DUAL-IN-LINE SIDE-BRAZED CERAMIC PACKAGES

(D) SUFFIX  
18-Lead Dual-In-Line  
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.890	0.915		22.606	23.241
C	—	0.200		—	5.080
D	0.015	0.021		0.381	0.533
F	0.054	REF.	1	1.371	REF.
G	0.100	BSC	1	2.54	BSC
H	0.035	0.065		0.889	1.651
J	0.008	0.012	3	0.203	0.304
K	0.125	0.150		3.175	3.810
L	0.290	0.310	2	7.366	7.874
M	—	0°		0°	15°
P	0.025	0.045		0.635	1.143
N	18			18	

92CS-27231R1

(D) SUFFIX  
22-Lead Dual-In-Line  
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.065	1.100		27.05	27.84
C	0.085	0.145		2.16	3.68
D	0.017	0.023		0.43	0.58
F	0.040	REF.	1	1.02	REF.
G	0.100	BSC	1	2.54	BSC
H	0.030	0.070		0.76	1.78
J	0.008	0.012	3	0.20	0.30
K	0.125	0.175		3.18	4.45
L	0.380	0.420	2	9.65	10.67
M	—	7°		—	7°
P	0.025	0.050		0.64	1.27
N	22			22	

92CS-25186R2

NOTES:

1. Leads within 0.005" (0.13 mm) radius of True Position at maximum material condition.
2. Dimension "L" to center of leads when formed parallel.
3. When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).

(D) SUFFIX  
24-Lead Dual-In-Line  
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.180	1.220		29.98	30.98
C	0.085	0.145		2.16	3.68
D	0.015	0.023		0.39	0.58
F	0.040	REF.		1.02	REF.
G	0.100	BSC	1	2.54	BSC
H	0.030	0.070		0.77	1.77
J	0.008	0.012	3	0.21	0.30
K	0.125	0.175		3.18	4.44
L	0.580	0.620	2	14.74	15.74
M	—	7°		—	7°
P	0.025	0.050		0.64	1.27
N	24			24	

92CS-30986R1

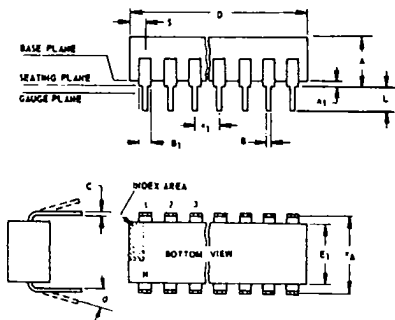
(D) SUFFIX  
40-Lead Dual-In-Line  
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.980	2.020		50.30	51.30
C	0.095	0.155		2.43	3.93
D	0.017	0.023		0.43	0.58
F	0.050	REF.		1.27	REF.
G	0.100	BSC	1	2.54	BSC
H	0.030	0.070		0.76	1.78
J	0.008	0.012	3	0.20	0.30
K	0.125	0.175		3.18	4.45
L	0.580	0.620	2	14.74	15.74
M	—	7°		—	7°
P	0.025	0.050		0.64	1.27
N	40			40	

92CM-27029R2

Dual-In-Line Plastic and Frit-Seal Ceramic Packages

(E) SUFFIX (JEDEC MO-001-AN)  
8-Lead Dual-In-Line Plastic  
(Mini-DIP) Package



SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A <sub>1</sub>	0.020	0.050		0.508	1.27
B	0.014	0.020		0.356	0.508
B <sub>1</sub>	0.035	0.065		0.889	1.65
C	0.008	0.012	1	0.203	0.304
D	0.370	0.400		9.40	10.16
E	0.300	0.325		7.62	8.25
E <sub>1</sub>	0.240	0.260		6.10	6.60
a <sub>1</sub>	0.100	TP	2	2.54	TP
a <sub>A</sub>	0.300	TP	2, 3	7.62	TP
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0.000	0.030		0.000	0.762
a	0	15	4	0	15
N	8		5	8	
N <sub>1</sub>	0		6	0	
O <sub>1</sub>	0.040	0.075		1.02	1.90
S	0.015	0.060		0.381	1.52

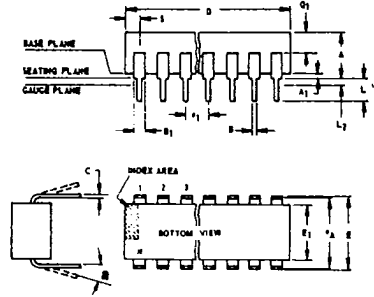
92CS-24026R1

NOTES:

- Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
1. When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013".
  2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
  3. a<sub>A</sub> applies in zone L<sub>2</sub> when unit installed.
  4. a applies to spread leads prior to installation.
  5. N is the maximum quantity of lead positions.
  6. N<sub>1</sub> is the quantity of allowable missing leads.

Dimensional Outlines (Cont'd)

Dual-In-Line Plastic and Frit-Seal Ceramic Packages (Cont'd)



NOTES:  
Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.  
1. When this device is supplied solder dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).  
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.  
3. eA applies in zone L2 when unit installed.  
4. a applies to spread leads prior to installation.  
5. N is the maximum quantity of lead positions.  
6. N1 is the quantity of allowable missing leads.

(E) and (F) SUFFIXES (JEDEC MO-001-AB)  
14-Lead Dual-In-Line Plastic or Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A <sub>1</sub>	0.020	0.050		0.51	1.27
B	0.014	0.020		0.356	0.508
B <sub>1</sub>	0.050	0.065		1.27	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.770		18.93	19.55
E	0.300	0.325		7.62	8.25
E <sub>1</sub>	0.240	0.260		6.10	6.60
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0.000	0.030		0.000	0.76
a	0°	15°	4	0°	15°
N	14	5	5	14	5
N <sub>1</sub>	0	6	6	0	0
Q <sub>1</sub>	0.040	0.075		1.02	1.90
S	0.065	0.090		1.66	2.28

92CS-4298R3

(E) and (F) SUFFIXES (JEDEC MO-001-AC)  
16-Lead Dual-In-Line Plastic or Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A <sub>1</sub>	0.020	0.050		0.51	1.27
B	0.014	0.020		0.356	0.508
B <sub>1</sub>	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.785		18.93	19.93
E	0.300	0.325		7.62	8.25
E <sub>1</sub>	0.240	0.260		6.10	6.60
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0.000	0.030		0.000	0.76
a	0°	15°	4	0°	15°
N	16	5	5	16	5
N <sub>1</sub>	0	6	6	0	0
Q <sub>1</sub>	0.040	0.075		1.02	1.90
S	0.015	0.080		0.39	1.52

92CM-15967R4

(E) SUFFIX  
18-Lead Dual-In-Line Plastic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A <sub>1</sub>	0.020	0.050		0.508	1.27
B	0.014	0.020		0.356	0.508
B <sub>1</sub>	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.845	0.885		21.47	22.47
E <sub>1</sub>	0.240	0.260		6.10	6.60
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
a	0°	15°	4	0°	15°
N	18	5	5	18	5
N <sub>1</sub>	0	6	6	0	0
S	0.015	0.060		0.39	1.52

92CS-30630

(E) SUFFIX  
22-Lead Dual-In-Line Plastic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A <sub>1</sub>	0.020	0.050		0.508	1.27
B	0.015	0.020		0.381	0.508
B <sub>1</sub>	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D		1.120			28.44
E	0.390	0.420		9.91	10.66
E <sub>1</sub>	0.345	0.355		8.77	9.01
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.400 TP		2, 3	10.16 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0	0.030		0	0.762
a	2°	15°	4	2°	15°
N	22	5	5	22	5
N <sub>1</sub>	0	6	6	0	0
Q <sub>1</sub>	0.055	0.085		1.40	2.15
S	0.015	0.060		0.381	1.27

92CS-30830

(F) SUFFIX (JEDEC MO-001-AG)  
16-Lead Dual-In-Line Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.165	0.210		4.20	5.33
A <sub>1</sub>	0.015	0.045		0.381	1.14
B	0.015	0.020		0.381	0.508
B <sub>1</sub>	0.045	0.070		1.15	1.77
C	0.009	0.011	1	0.229	0.279
D	0.750	0.795		19.05	20.19
E	0.295	0.325		7.50	8.25
E <sub>1</sub>	0.245	0.300		6.23	7.62
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.300 TP		2, 3	7.62 TP	
L	0.120	0.160		3.05	4.06
L <sub>2</sub>	0.000	0.030		0.000	0.76
a	2°	15°	4	2°	15°
N	16	5	5	16	5
N <sub>1</sub>	0	6	6	0	0
Q <sub>1</sub>	0.050	0.080		1.27	2.03
S	0.010	0.060		0.254	1.52

92CM-22284R1

(E) and (F) SUFFIXES (JEDEC MO-015-AA)  
24-Lead Dual-In-Line Plastic or Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.250		3.10	6.30
A <sub>1</sub>	0.020	0.070		0.51	1.77
B	0.016	0.020		0.407	0.508
B <sub>1</sub>	0.028	0.070		0.72	1.77
C	0.008	0.012	1	0.204	0.304
D	1.20	1.29		30.48	32.76
E	0.600	0.625		15.24	15.87
E <sub>1</sub>	0.515	0.580		13.09	14.73
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.600 TP		2, 3	15.24 TP	
L	0.100	0.200		2.54	5.00
L <sub>2</sub>	0.000	0.030		0.00	0.76
a	0°	15°	4	0°	15°
N	24	5	5	24	5
N <sub>1</sub>	0	6	6	0	0
Q <sub>1</sub>	0.040	0.075		1.02	1.90
S	0.040	0.100		1.02	2.54

92CS26938R2

(E) SUFFIX  
40-Lead Dual-In-Line Plastic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.250		3.10	6.30
A <sub>1</sub>	0.020	0.070		0.51	1.77
B	0.016	0.020		0.407	0.508
B <sub>1</sub>	0.028	0.070		0.72	1.77
C	0.008	0.012	1	0.204	0.304
D	2.000	2.090		50.80	53.09
E <sub>1</sub>	0.515	0.580		13.09	14.73
e <sub>1</sub>	0.100 TP		2	2.54 TP	
e <sub>A</sub>	0.600 TP		2, 3	15.24 TP	
L	0.100	0.200		2.54	5.00
L <sub>2</sub>	0.000	0.030		0.00	0.76
a	0°	15°	4	0°	15°
N	40	5	5	40	5
N <sub>1</sub>	0	6	6	0	0
Q <sub>1</sub>	0.065	0.095		1.66	2.41
S	0.040	0.100		1.02	2.54

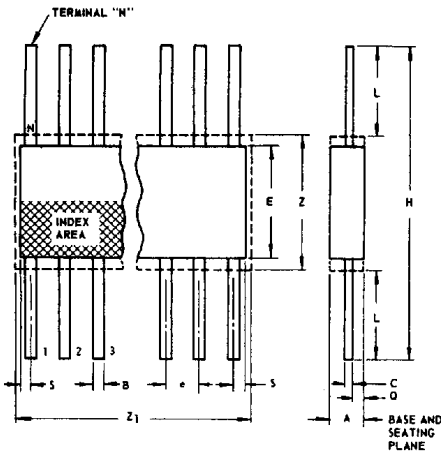
92CS-30959

T-90-20

Dimensional Outlines (Cont'd)

Ceramic Flat Packs

(K) SUFFIX (JEDEC MO-004-AF)  
14-Lead



SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.008	0.100		0.21	2.54
B	0.015	0.019	1	0.381	0.482
C	0.003	0.006	1	0.077	0.152
e	0.050 TP		2	1.27 TP	
E	0.200	0.300		5.1	7.6
H	0.600	1.000		15.3	25.4
L	0.150	0.350		3.9	8.8
N	14		3	14	
Q	0.005	0.050		0.13	1.27
S	0.000	0.050		0.00	1.27
Z	0.300		4	7.62	
Z <sub>1</sub>	0.400		4	10.16	

92CS-4300R3

NOTES:

1. Refer to JEDEC Publication No. 95 for Rules for Dimensioning Peripheral Lead Outlines.
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at maximum material condition.
3. N is the maximum quantity of lead positions.
4. Z and Z<sub>1</sub> determine a zone within which all body and lead irregularities lie.

(K) SUFFIX (JEDEC MO-004-AG)  
16-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.008	0.100		0.21	2.54
B	0.015	0.019	1	0.381	0.482
C	0.003	0.006	1	0.077	0.152
e	0.050 TP		2	1.27 TP	
E	0.200	0.300		5.1	7.6
H	0.600	1.000		15.3	25.4
L	0.150	0.350		3.9	8.8
N	16		3	16	
Q	0.005	0.050		0.13	1.27
S	0.000	0.025		0.00	0.63
Z	0.300		4	7.62	
Z <sub>1</sub>	0.400		4	10.16	

92CS-17271R3

(K) SUFFIX  
24-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.075	0.120		1.91	3.04
B	0.018	0.022	1	0.458	0.558
C	0.004	0.007	1	0.102	0.177
e	0.060 TP		2	1.27 TP	
E	0.600	0.700		15.24	17.78
H	1.150	1.350		29.21	34.29
L	0.225	0.325		5.72	8.25
N	24		3	24	
Q	0.035	0.070		0.89	1.77
S	0.060	0.110	1	1.53	2.79
Z	0.700		4	17.78	
Z <sub>1</sub>	0.750		4	19.05	

92CS-19949R2

(K) SUFFIX  
28-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.075	0.120		1.91	3.04
B	0.018	0.022	1	0.458	0.558
C	0.004	0.007	1	0.102	0.177
e	0.050 TP		2	1.27 TP	
E	0.600	0.700		15.24	17.78
H	1.150	1.350		29.21	34.29
L	0.225	0.325		5.72	8.25
N	28		3	28	
Q	0.035	0.070		0.89	1.77
S	0	0.060	1	0	1.53
Z	0.700		4	17.78	
Z <sub>1</sub>	0.750		4	19.05	

92CS-20972